



## General Description

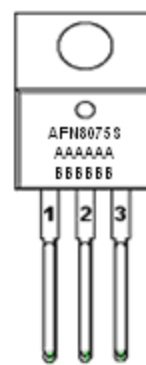
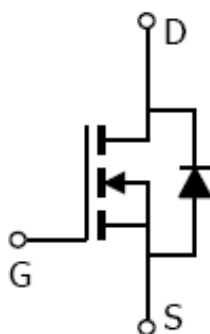
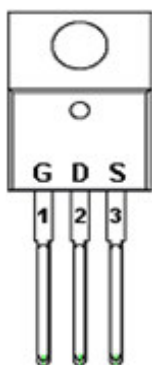
AFN8075S, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge.

These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

## Features

- 80V/40A,  $R_{DS(ON)} = 11m\Omega @ V_{GS} = 10V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- TO-220-3L package design

## Pin Description ( TO-220-3L )



## Application

- Switching
- DC-DC converter and DC motor control
- UPS

## Pin Define

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

## Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN8075ST220TG	AFN8075S AAAAAA BBBBBB	TO-220-3L	Tube	50 EA

- ※ A Lot code
- ※ B Date code
- ※ AFN8075ST220TG : Tube ; Pb- Free ; Halogen- Free



**Absolute Maximum Ratings**

(T<sub>c</sub>=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	80	V
Gate –Source Voltage	V <sub>GSS</sub>	±25	V
Continuous Drain Current(T <sub>J</sub> =150°C)	I <sub>D</sub>	T <sub>C</sub> =25°C	90
		T <sub>C</sub> =70°C	70
Pulsed Drain Current	I <sub>DM</sub>	200	A
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	50	
Power Dissipation	P <sub>D</sub>	T <sub>C</sub> =25°C	150
		T <sub>A</sub> =25°C	3.75
Operating Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	62.5	°C/W

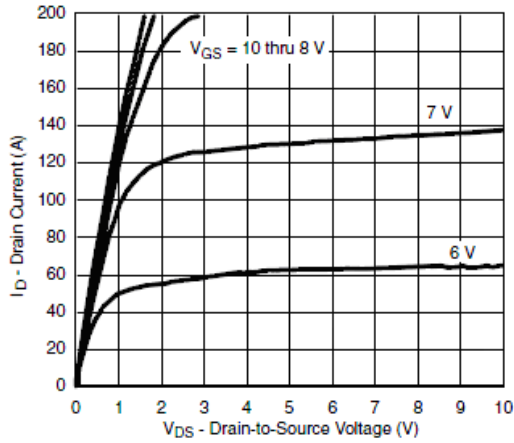
**Electrical Characteristics**

(T<sub>A</sub>=25°C Unless otherwise noted)

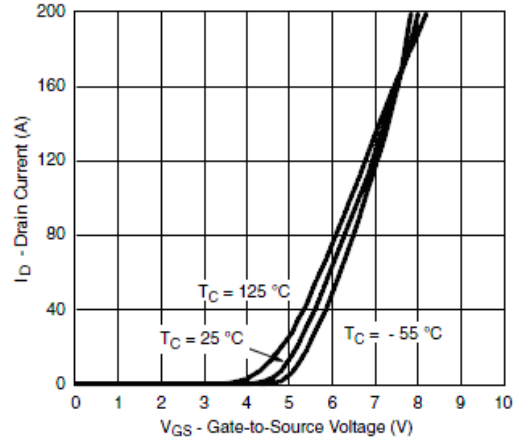
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	80			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2.0		4.0	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =64V, V <sub>GS</sub> =0V			1	uA
		V <sub>DS</sub> =64V, V <sub>GS</sub> =0V T <sub>J</sub> =85°C			30	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ 10V, V <sub>GS</sub> =10V	75			A
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =40A		7.05	10	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =15V, I <sub>D</sub> =30A		55		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =30A, V <sub>GS</sub> =0V		0.8	1.5	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =38V, V <sub>GS</sub> =10V I <sub>D</sub> ≡15A		58	98	nC
Gate-Source Charge	Q <sub>gs</sub>			22		
Gate-Drain Charge	Q <sub>gd</sub>			15		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V f=1MHz		3500		pF
Output Capacitance	C <sub>oss</sub>			480		
Reverse Transfer Capacitance	C <sub>rss</sub>			200		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =38V, R <sub>L</sub> =3.1Ω I <sub>D</sub> ≡12.5A, V <sub>GEN</sub> =10V R <sub>G</sub> =1.0Ω		20	45	ns
	t <sub>r</sub>			15	30	
Turn-Off Time	t <sub>d(off)</sub>			35	60	
	t <sub>f</sub>			10	20	



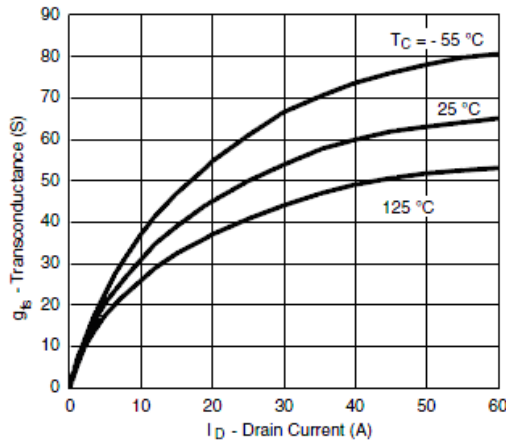
## Typical Characteristics



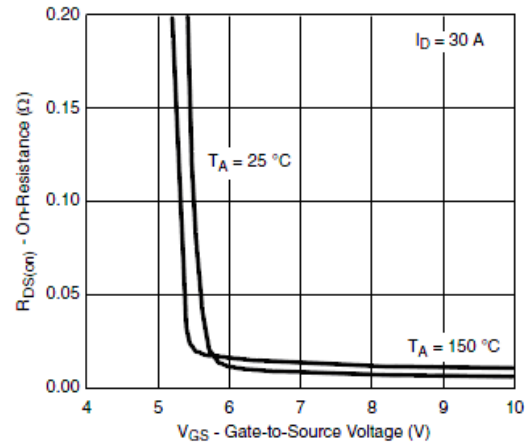
Output Characteristics



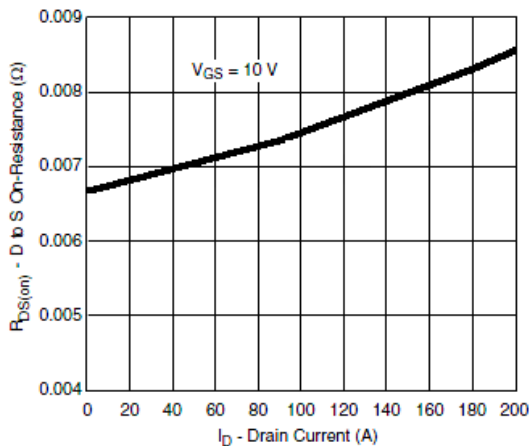
Transfer Characteristics



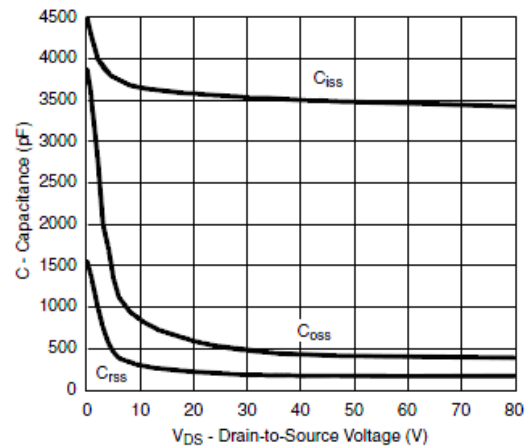
Transconductance



On-Resistance vs. Gate-to-Source Voltage vs. Temperature



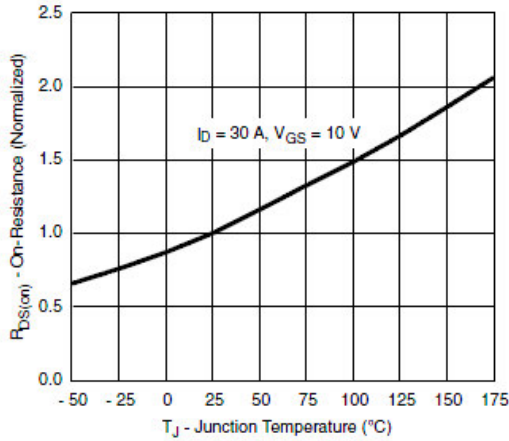
On-Resistance vs. Drain Current



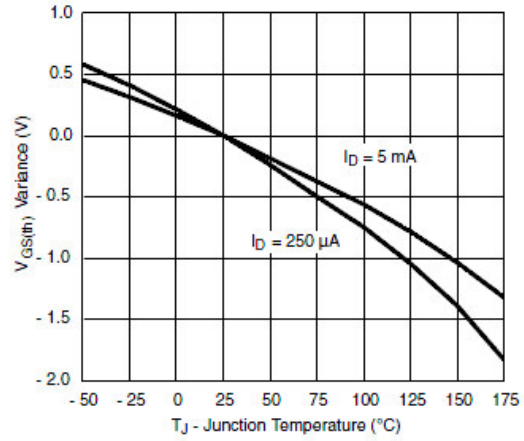
Capacitance



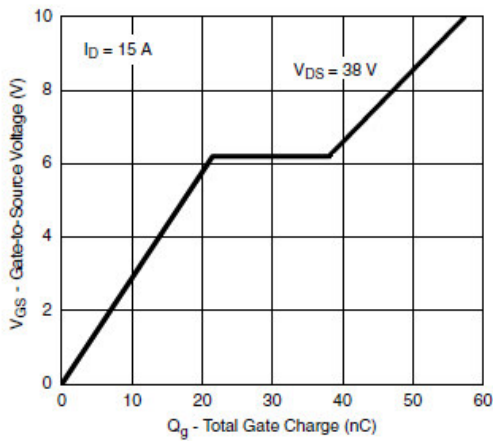
## Typical Characteristics



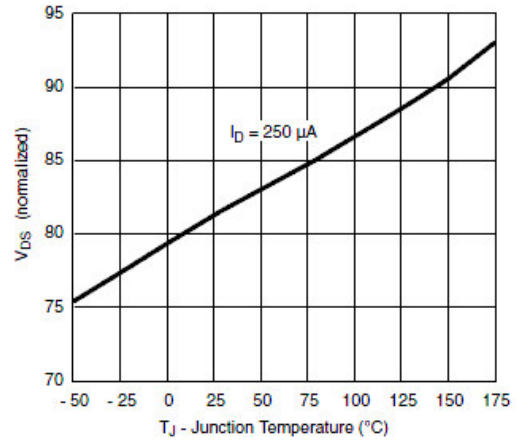
On-Resistance vs. Junction Temperature



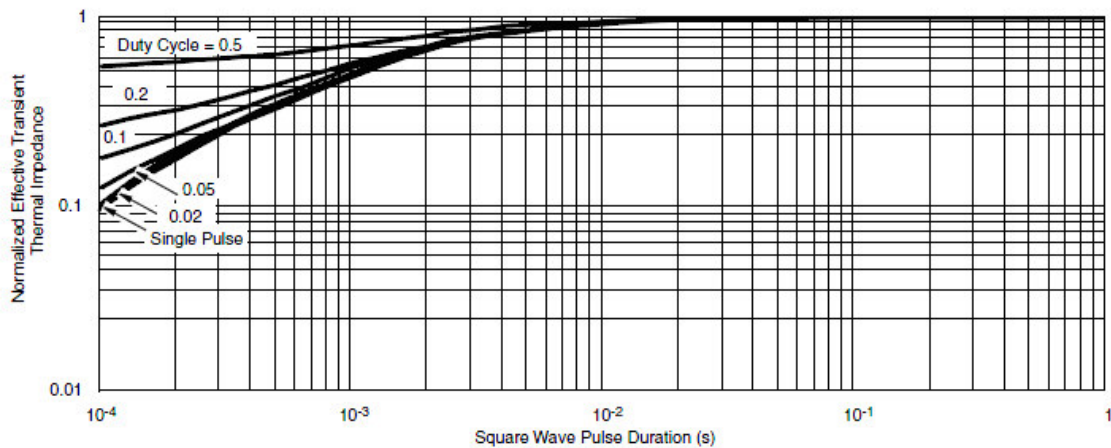
Threshold Voltage



Gate Charge



Drain Source Breakdown vs. Junction Temperature



Normalized Thermal Transient Impedance, Junction-to-Case



**Typical Characteristics**

Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

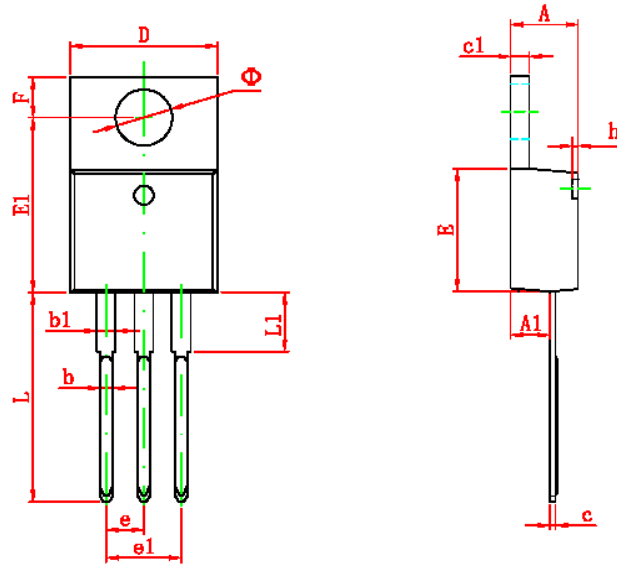


Unclamped Inductive Switching Test Circuit & Waveforms





**Package Information ( TO-220-3L )**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.470	4.670	0.176	0.184
A1	2.520	2.820	0.099	0.111
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
E1	12.060	12.460	0.475	0.491
e	2.540 TYP		0.100 TYP	
e1	4.980	5.180	0.196	0.204
F	2.590	2.890	0.102	0.114
h	0.000	0.300	0.000	0.012
L	13.400	13.800	0.528	0.543
L1	3.560	3.960	0.140	0.156
• •	3.735	3.935	0.147	0.155

©2010 Alfa-MOS Technology Corp.  
2F, No.80, Sec.1, Cheng Kung Rd., Nan Kang Dist., Taipei City 115, Taiwan (R.O.C.)  
Tel : 886 2) 2651 3928  
Fax : 886 2) 2786 8483  
©http://www.alfa-mos.com